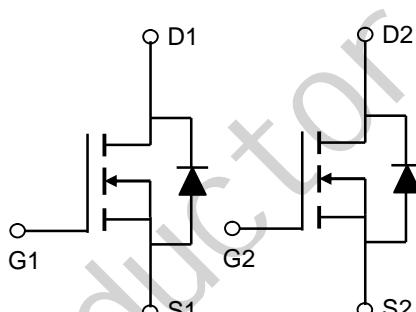
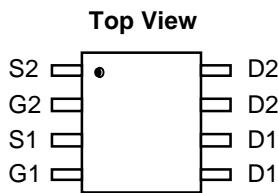


## ■ DESCRIPTION

The 4828 is the N-Channel logic enhancement mode power field effect transistor, is produced using high cell density advanced trench technology. This high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage application, notebook computer power management and other battery powered circuits.



## ■ FEATURE

- ◆ 60V/6.3A,  $R_{DS(ON)}=30m\Omega$  (typ.)@ $VGS= 10V$
- ◆ 60V/5.0A,  $R_{DS(ON)}=37m\Omega$  (typ.)@ $VGS= 4.5V$
- ◆ Super high design for extremely low  $R_{DS(ON)}$
- ◆ Exceptional on-resistance and Maximum DC current capability
- ◆ Full RoHS compliance
- ◆ SOP8 package design

## ■ APPLICATIONS

- ◆ Power Management
- ◆ Portable Equipment
- ◆ DC/DC Converter
- ◆ Load Switch
- ◆ DSC
- ◆ LCD Display inverter

## ■ ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ C$ Unless otherwise noted )

Parameter	Symbol	Maximum	Units
Drain-Source Voltage	$V_{DS}$	60	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Continuous Drain Current <sup>A</sup>	$I_D$	6.3	A
$T_A=70^\circ C$		5	
Pulsed Drain Current <sup>B</sup>	$I_{DM}$	40	
Power Dissipation	$P_D$	2	W
$T_A=70^\circ C$		1.28	
Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to 150	°C

Thermal Characteristics				
Parameter	Symbol	Typ	Max	Units
Maximum Junction-to-Ambient <sup>A</sup>	$R_{\theta JA}$	50	62.5	°C/W
Maximum Junction-to-Ambient <sup>A</sup>		73	110	°C/W
Maximum Junction-to-Lead <sup>C</sup>	$R_{\theta JL}$	31	40	°C/W

**Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.**

**Absolute maximum ratings are stress rating only and functional device operation is not implied**

■ **ELECTRICAL CHARACTERISTICS**( $T_A=25^\circ C$  Unless otherwise noted)

Symbol	Parameter	Condition	Min	Typ	Max	Unit	
<b>Static Parameters</b>							
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D= 250\mu A$	60			V	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D= 250\mu A$	1.0	1.8	3.0	V	
$I_{GSS}$	Gate Leakage Current	$V_{DS}=0V, V_{GS}=\pm 20V$			$\pm 100$	nA	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}= 48V, V_{GS}=0$			1	uA	
		$V_{DS}= 48V, V_{GS}=0$ $T_J=55^\circ C$			5		
$R_{DS(ON)}$	Drain-Source On-Resistance	$V_{GS}= 10V, I_D= 6.3A$		30	45	mΩ	
		$V_{GS}= 4.5V, I_D= 5.0A$		37	55		
<b>Source-Drain Diode</b>							
$V_{SD}$	Diode Forward Voltage	$I_S= 1.0A, V_{GS}=0V$		0.8	1.3	V	
<b>Dynamic Parameters</b>							
$Q_g$	Total Gate Charge	$V_{DS}= 30V$ $V_{GS}= 10V$ $I_D= 5.0A$		15.6	16	nC	
$Q_{gs}$	Gate-Source Charge			1.3			
$Q_{gd}$	Gate-Drain Charge			4.5			
$C_{iss}$	Input Capacitance	$V_{DS}= 25V$ $V_{GS}=0V$ $f=1MHz$		520		pF	
$C_{oss}$	Output Capacitance			105			
$C_{rss}$	Reverse Transfer Capacitance			60			
$T_{d(on)}$	Turn-On Time	$V_{DS}= 30V$ $I_D= 1A$ $V_{GEN}= 10V$ $R_G=6\Omega$		8	16	nS	
$T_r$				6	12		
$T_{d(off)}$	Turn-Off Time			25	46		
$T_f$				4	8		

**Note:** 1. Pulse test: pulse width<=300uS, duty cycle<=2%

2. Static parameters are based on package level with recommended wire bonding

■ **TYPICAL CHARACTERISTICS (25 °C Unless Note)**

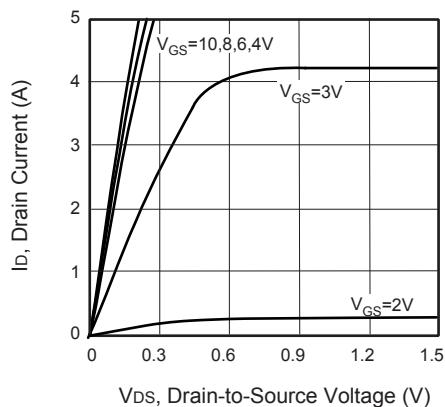


Figure 1. Output Characteristics

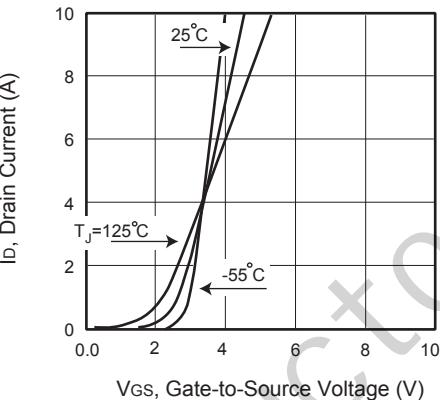


Figure 2. Transfer Characteristics

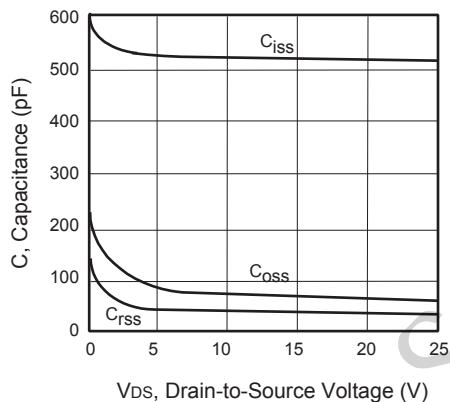


Figure 3. Capacitance

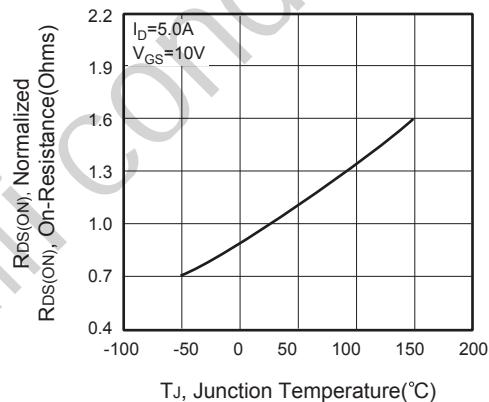


Figure 4. On-Resistance Variation with Temperature

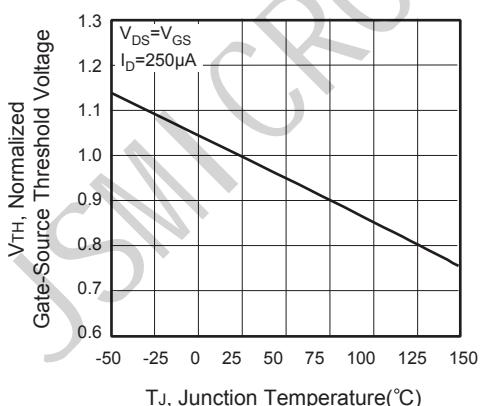


Figure 5. Gate Threshold Variation with Temperature

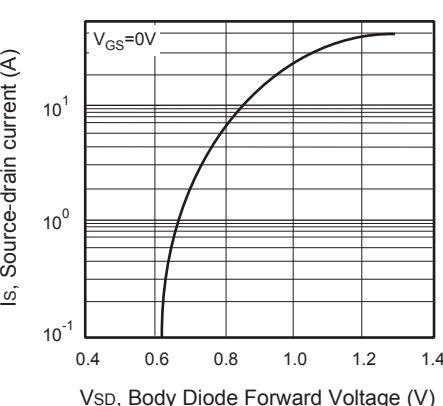
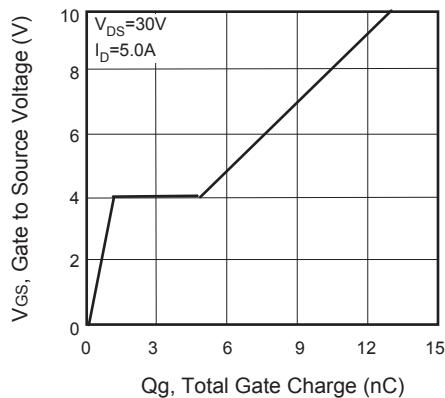
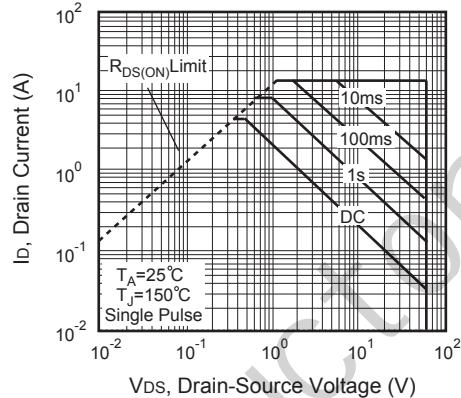
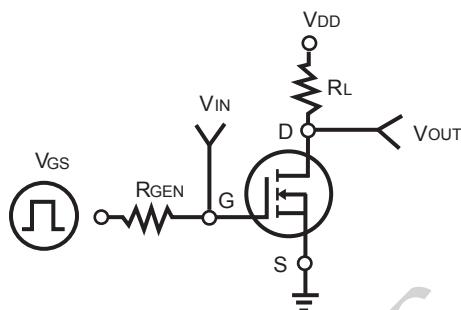
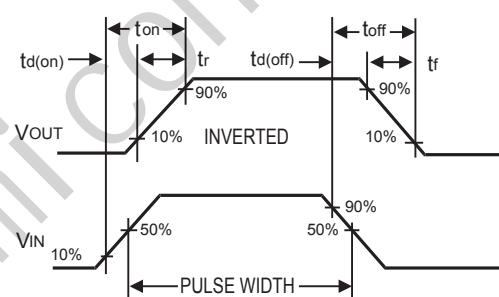
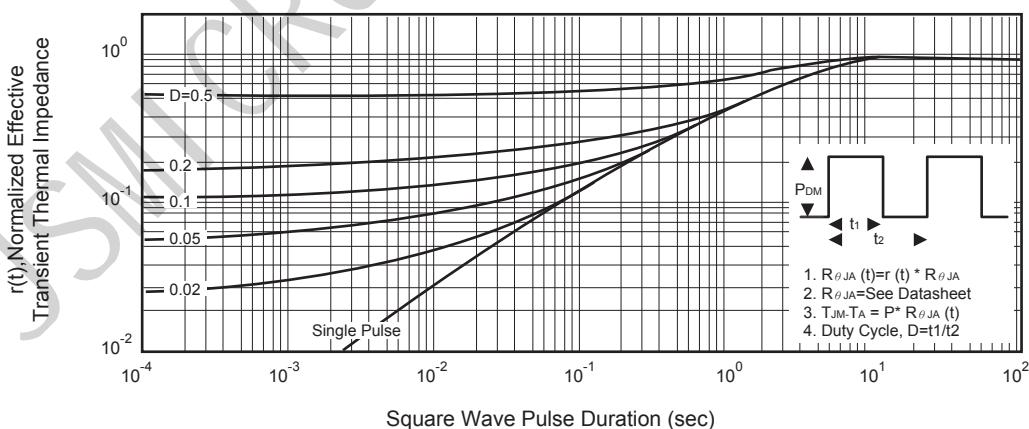
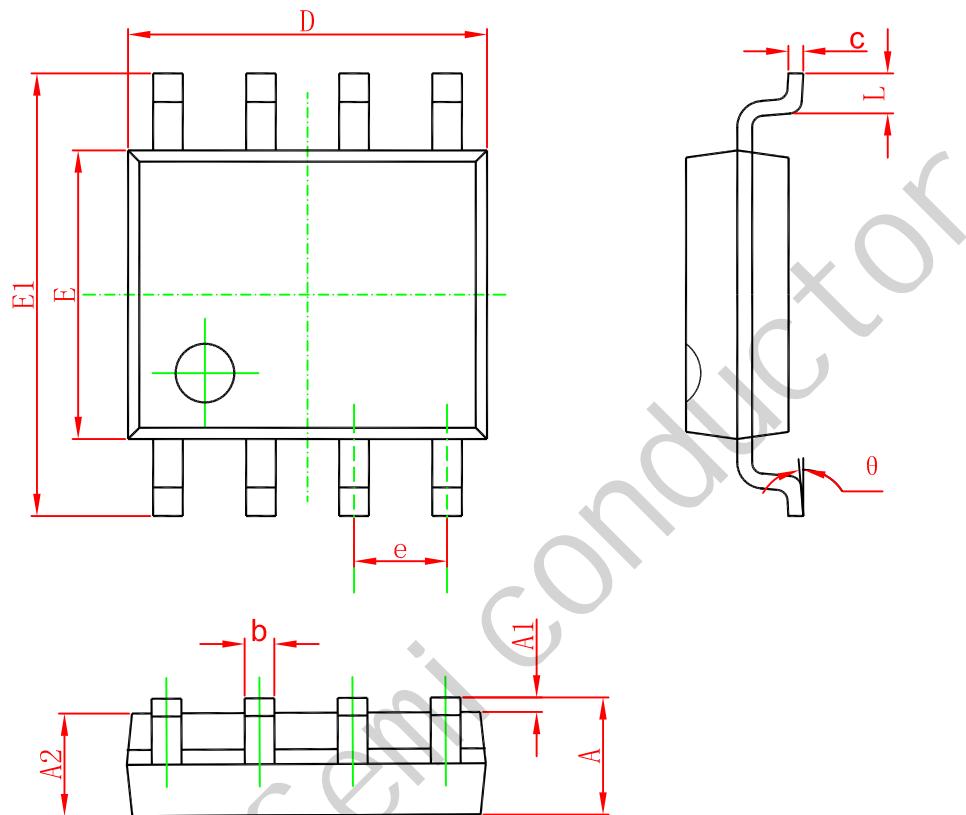


Figure 6. Body Diode Forward Voltage Variation with Source Current

■ **TYPICAL CHARACTERISTICS (continuous)**

**Figure 7. Gate Charge**

**Figure 8. Maximum Safe Operating Area**

**Figure 9. Switching Test Circuit**

**Figure 10. Switching Waveforms**

**Figure 11. Normalized Thermal Transient Impedance Curve**

## ■ SOP8 PACKAGE OUTLINE DIMENSIONS



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.006	0.010
D	4.700	5.100	0.185	0.200
E	3.800	4.000	0.150	0.157
E1	5.800	6.200	0.228	0.244
e	1.270 (BSC)		0.050 (BSC)	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°